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AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application.

Claims 1-16 (Canceled)

17. (Currently Amended) A method for manufacturing a semiconductor device comprising:

depositing a film over a substrate by repeatedly moving an evaporation source in an X direction ~~and then~~ while moving the substrate in a Y direction at regular intervals.

18. (Previously Presented) The method according to claim 17, wherein the semiconductor device is incorporated into an electronic apparatus selected from the group consisting of a video camera, a digital camera, a goggle display, a navigation system, an audio reproducing apparatus, a laptop computer, a game machine, a mobile computer, a cellular phone, a portable game machine, an electronic book, and an image reproducing apparatus.

19. (Currently Amended) A method for manufacturing a semiconductor device comprising:

depositing a film over a substrate by repeatedly moving the substrate in a Y direction at regular intervals while making a movement speed of a first evaporation source in an X direction and a movement speed of a second evaporation source in the X direction different, wherein the first evaporation source and the second evaporation source are provided in a same chamber.

20. (Previously Presented) The method according to claim 19, wherein the semiconductor device is incorporated into an electronic apparatus selected from the group consisting of a video camera, a digital camera, a goggle display, a navigation system, an audio reproducing apparatus, a laptop computer, a game machine, a mobile computer, a

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cellular phone, a portable game machine, an electronic book, and an image reproducing apparatus.

21. (Previously Presented) A method for manufacturing a semiconductor device comprising:

depositing a film over a substrate by moving or reciprocating an evaporation source in the X direction while moving the substrate in the Y direction at a constant speed.

22. (Previously Presented) The method according to claim 21, wherein the semiconductor device is incorporated into an electronic apparatus selected from the group consisting of a video camera, a digital camera, a goggle display, a navigation system, an audio reproducing apparatus, a laptop computer, a game machine, a mobile computer, a cellular phone, a portable game machine, an electronic book, and an image reproducing apparatus.

23. (Currently Amended) A method for manufacturing a semiconductor device comprising:

depositing an EL material over a substrate by repeatedly moving an evaporation source in an X direction ~~and then~~ while moving the substrate in a Y direction at regular intervals.

24. (Previously Presented) The method according to claim 23, wherein the semiconductor device is incorporated into an electronic apparatus selected from the group consisting of a video camera, a digital camera, a goggle display, a navigation system, an audio reproducing apparatus, a laptop computer, a game machine, a mobile computer, a cellular phone, a portable game machine, an electronic book, and an image reproducing apparatus.

25. (Currently Amended) A method for manufacturing a semiconductor device comprising:

depositing an EL material over a substrate by repeatedly moving the substrate in a Y

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direction at regular intervals while making a movement speed of a first evaporation source in an X direction and a movement speed of a second evaporation source in the X direction different,

wherein the first evaporation source and the second evaporation source are provided in a same chamber.

26. (Previously Presented) The method according to claim 25, wherein the semiconductor device is incorporated into an electronic apparatus selected from the group consisting of a video camera, a digital camera, a goggle display, a navigation system, an audio reproducing apparatus, a laptop computer, a game machine, a mobile computer, a cellular phone, a portable game machine, an electronic book, and an image reproducing apparatus.

27. (Previously Presented) A method for manufacturing a semiconductor device comprising:

depositing an EL material over a substrate by moving or reciprocating an evaporation source in the X direction while moving the substrate in the Y direction at a constant speed.

28. (Previously Presented) The method according to claim 27, wherein the semiconductor device is incorporated into an electronic apparatus selected from the group consisting of a video camera, a digital camera, a goggle display, a navigation system, an audio reproducing apparatus, a laptop computer, a game machine, a mobile computer, a cellular phone, a portable game machine, an electronic book, and an image reproducing apparatus.

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